

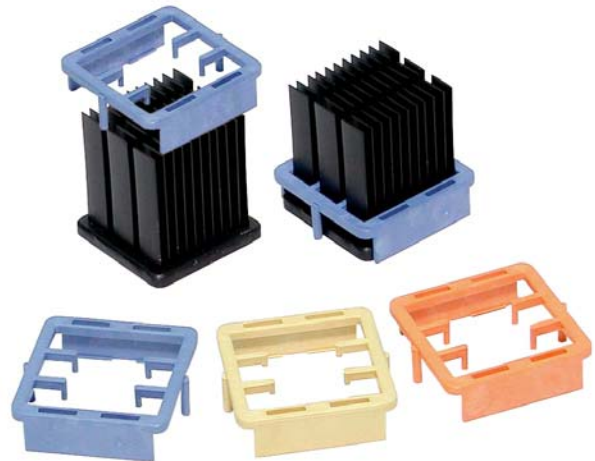


Model Name : MBA31001-15W/2.6

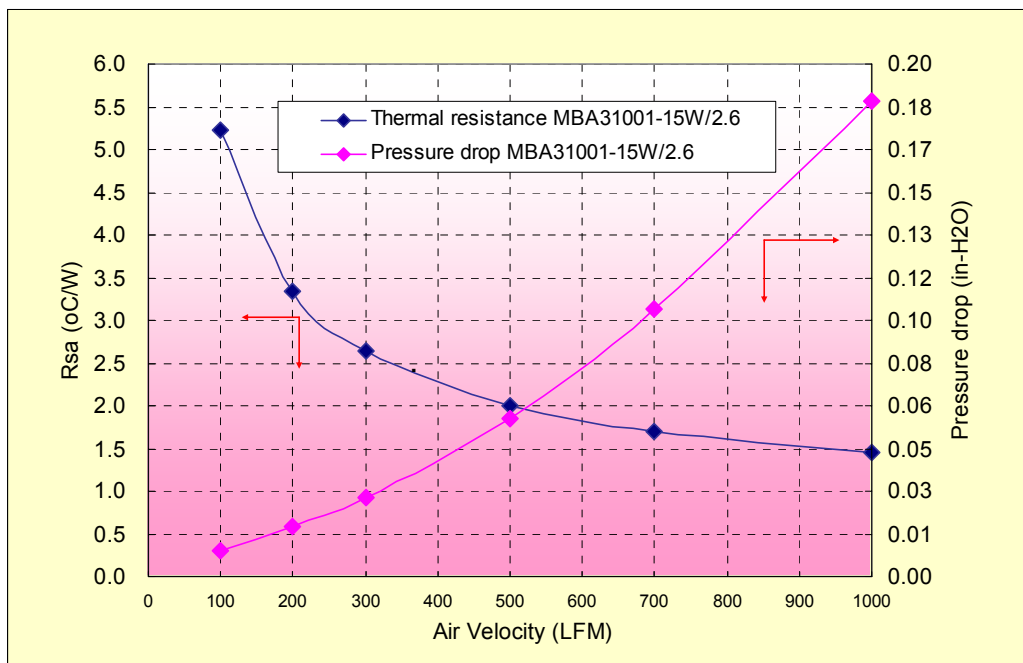
BGA Heat Sink For 31x31 Chip set

Specification:

1. Material:
Heat Sink : Aluminum 6063
Clip : Plastic (UL94-V0)
2. Heat Sink Dimension :
30.6*30.6*14.6 mm height (with base)
Base : 2.6mm, Fin height : 12mm
3. Weight: 15.3 gm
4. Technology: Precision Forging
5. Finish: Black or Nature Anodize
6. Clip available :
Chip set thickness
3.0-3.6mm - Yellow colored clip
1.4-2.0mm – Blue Colored clip
0.5-1.1mm – Orange colored clip



Performance Data:



Heat Source Size : Uniform



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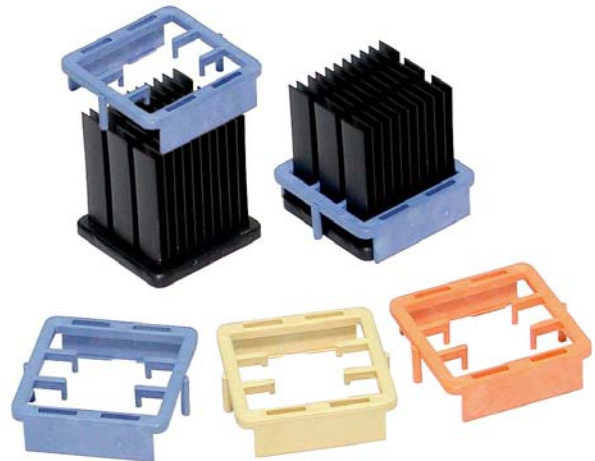


Model Name : MBA31001-28W/2.6

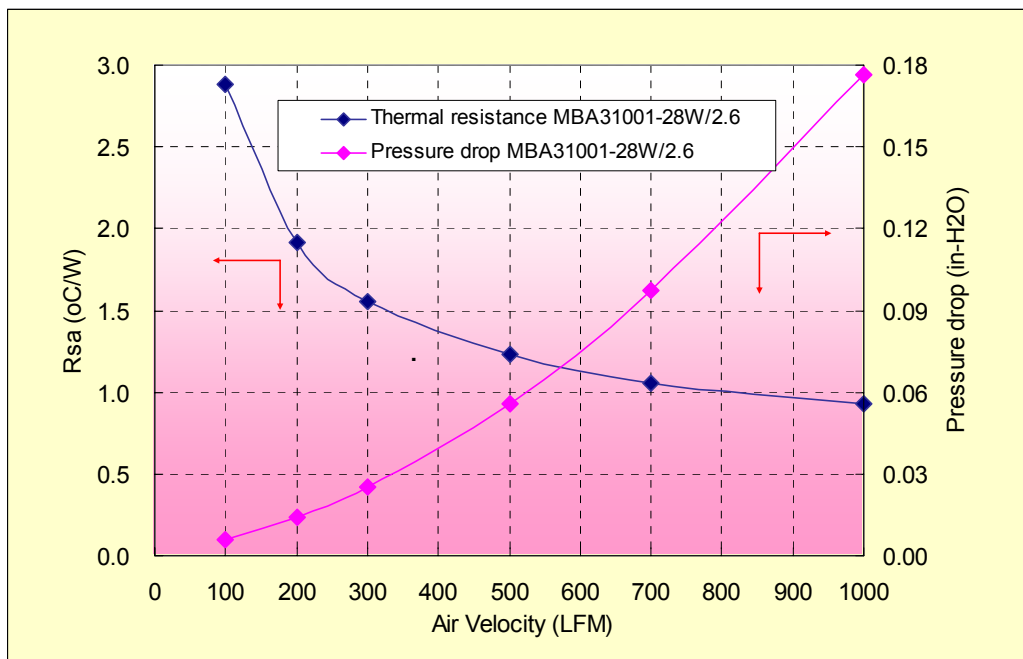
BGA Heat Sink For 31x31 Chip set

Specification:

1. Material:
Heat Sink : Aluminum 6063
Clip : Plastic (UL94-V0)
2. Heat Sink Dimension :
30.6*30.6*27.6 mm height (with base)
Base : 2.6mm, Fin height : 25mm
3. Weight: 21.1 gm
4. Technology: Precision Forging
5. Finish: Black or Nature Anodize
6. Clip available :
Chip set thickness
3.0-3.6mm - Yellow colored clip
1.4-2.0mm – Blue Colored clip
0.5-1.1mm – Orange colored clip



Performance Data:



Heat Source Size : Uniform



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